FEATURES

- * High Speed Switching
- * Low Saturation Voltage
 - : V_{CE}(sat) = 2.0 V (@ Ic=40A)
- * High Input Impedance
- *CO-PAK, IGBT with FRD
 - : Trr = 50nS (typ.)

APPLICATIONS

- * AC & DC Motor controls
- * General Purpose Inverters
- * Robotics , Servo Controls
- * Power Supply
- * Lamp Ballast

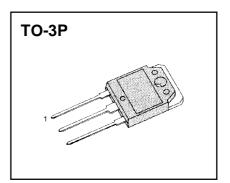
ABSOLUTE MAXIMUM RATINGS

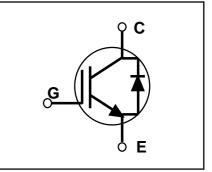
Symbol	Characteristics	Rating	Units	
V _{CES}	Collector-Emitter Voltage	600	V	
V _{GES}	Gate-Emitter Voltage	±20	V	
I _C	Collector Current @ Tc = 25°C	80	А	
	Collector Current @ Tc = 100°C	40	A	
I _{CM (1)}	Pulsed Collector Current	220	A	
I _F	Diode Continuous Forward Current @ Tc = 100°C	25	А	
I _{FM}	Diode Maximum Forward Current	280	A	
P _D	Maximum Power Dissipation @Tc = 25°C	195	W	
	Maximum Power Dissipation @Tc = 100°C	78	W	
Tj	Operating Junction Temperature	-55 ~ 150	°C	
Tstg	Storage Temperature Range	nperature Range -55 ~ 150 °C		
TL	Maximum Lead Temp. For Soldering	300	°C	
	Purposes, 1/8" from case for 5 seconds			

Notes:(1) Repetitive rating : Pulse width limited by max. junction temperature



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ELECTRICAL CHARACTERISTICS (IGBT PART)

(Tc=25°C,Unless Otherwise Specified)

Symbol	Characteristics	Test Conditions	Min	Тур	Max	Units
BV _{CES}	C - E Breakdown Voltage	$V_{GE} = 0V$, $I_C = 250uA$	600	-	-	V
$\Delta V_{CES/}$	Temperature Coeff. of	$V_{GE} = 0V$, $I_C = 1mA$	-	0.6	-	V/°C
ΔT_{J}	Breakdown Voltage					
V _{GE(th)}	G - E threshold voltage	$I_{\rm C}$ = 40mA , $V_{\rm CE}$ = $V_{\rm GE}$	4.5	5.5	7.5	V
I _{CES}	Collector cutoff Current	$V_{CE} = V_{CES}$, $V_{GE} = 0V$	-	-	250	uA
I _{GES}	G - E leakage Current	$V_{GE} = V_{GES}$, $V_{CE} = 0V$	-	-	100	nA
V _{CE} (sat)	Collector to Emitter	Ic=40A, V _{GE} = 15V	-	2.0	2.6	V
	saturation voltage	Ic=80A, V _{GE} = 15V	-	2.6	-	V
Cies	Input capacitance	$V_{GE} = 0V$, f = 1MHz	-	2790	-	pF
Coes	Output capacitance	V _{CE} = 30V	-	347	-	pF
Cres	Reverse transfer capacitance		-	96	-	pF
td(on)	Turn on delay time	$V_{\rm CC} = 300 V$, $I_{\rm C} = 40 {\rm A}$	-	17	-	ns
tr	Turn on rise time	V _{GE} = 15V	-	33	-	ns
td(off)	Turn off delay time	$R_{G} = 5\Omega$	-	97	130	ns
tf	Turn off fall time	Inductive Load	-	70	140	ns
Eon	Turn on Switching Loss		-	0.12	-	mJ
Eoff	Turn off Switching Loss		-	0.68	-	mJ
Ets	Total Switching Loss		-	0.8	1.5	mJ
Qg	Total Gate Charge	Vcc = 300V	-	178	267	nC
Qge	Gate-Emitter Charge	V _{GE} = 15V	-	40	60	nC
Qgc	Gate-Collector Charge	Ic = 40A	-	49	74	nC
Le	Internal Emitter Inductance	Measured 5mm from PKG	-	14	-	nH



ELECTRICAL CHARACTERISTICS (DIODE PART) (Tc=25°C,Unless Otherwise Specified)

Symbol	Characteristics	Test Conditions		Min	Тур	Max	Units
VFM	Diode Forward Voltage	IF=25A	Tc =25°C	-	1.4	1.7	V
			Tc =100°C	-	1.3	-	
Trr	Diode Reverse		Tc =25°C	-	50	75	nS
	Recovery Time		Tc =100°C	-	105	-	
Irr	Diode Peak Reverse	IF=25A, VR=200V	Tc =25°C	-	4.5	10	А
	Recovery Current	-di/dt=200A/uS	Tc =100°C	-	8.5	-	
Qrr	Diode Reverse		Tc =25°C	-	112	375	nC
	Recovery Charge		Tc =100°C	-	420	-	

THERMAL RESISTANCE

Symbol	Characteristics	Min	Тур	Max	Units
R ₀ JC	Junction-to-Case (IGBT)	-	-	0.64	°C/W
R _e JC	Junction-to-Case (DIODE)	-	-	0.83	°C/W
R _e JA	Junction-to-Ambient	-	-	40	°C/W
R₄CS	Case-to-Sink	-	0.24	-	°C/W



N-CHANNEL IGBT

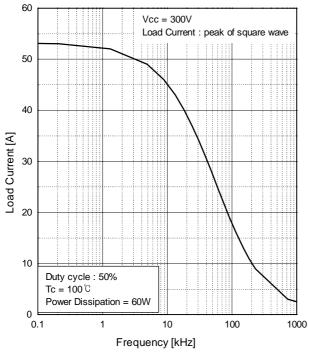


Fig.1 Typical Load Current vs. Frequency

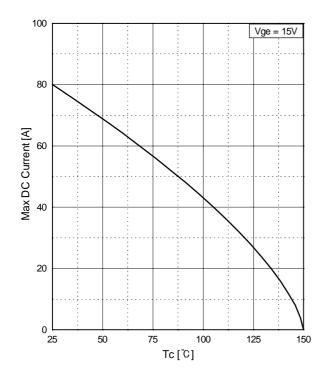


Fig.3 Maximum Collector Current vs. Case Temperature

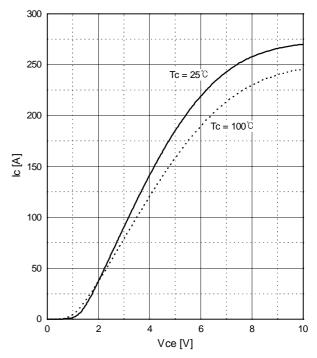


Fig.2 Typical Output Characteristics

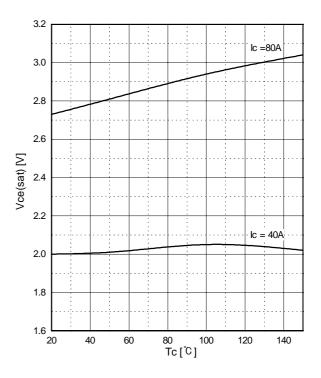


Fig.4 Collector to Emitter Voltage vs. Case Temperature



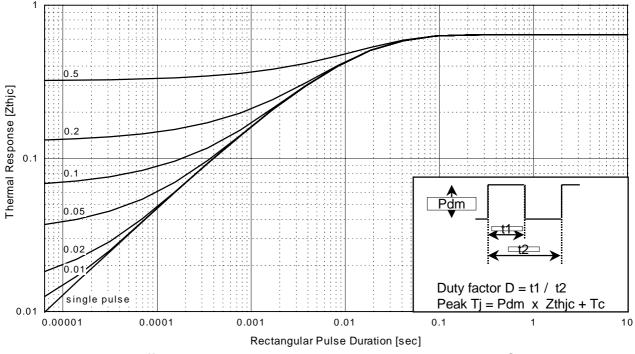
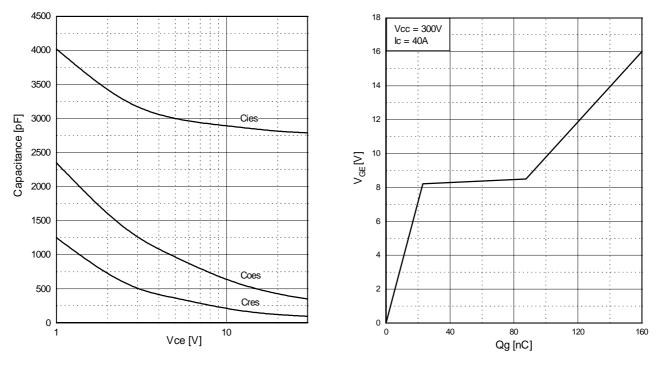
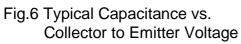
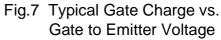


Fig.5 Maximum Effective Transient Thermal Impedance, Junction to Case









N-CHANNEL IGBT

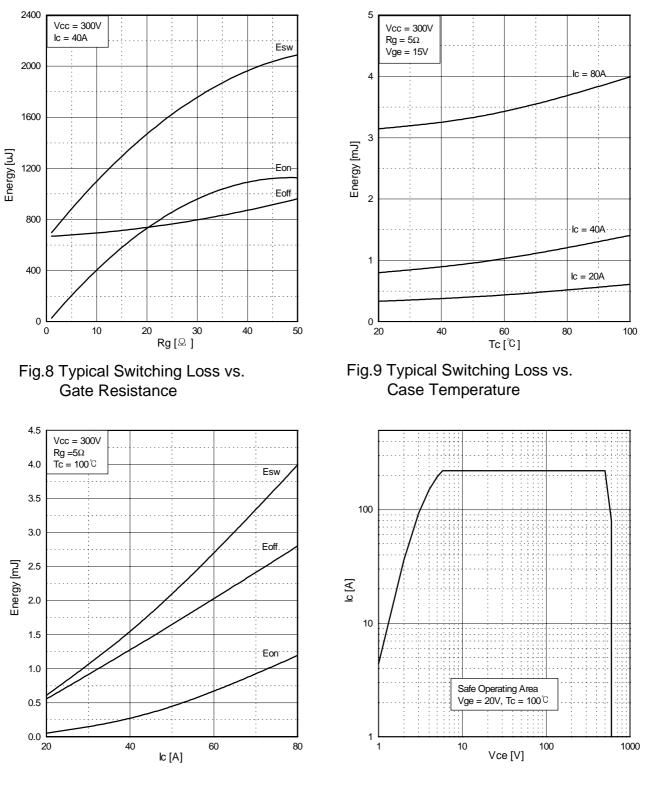


Fig.10 Typical Switching loss vs. Collector to Emitter Current Fig.11 Turn-off SOA



N-CHANNEL IGBT

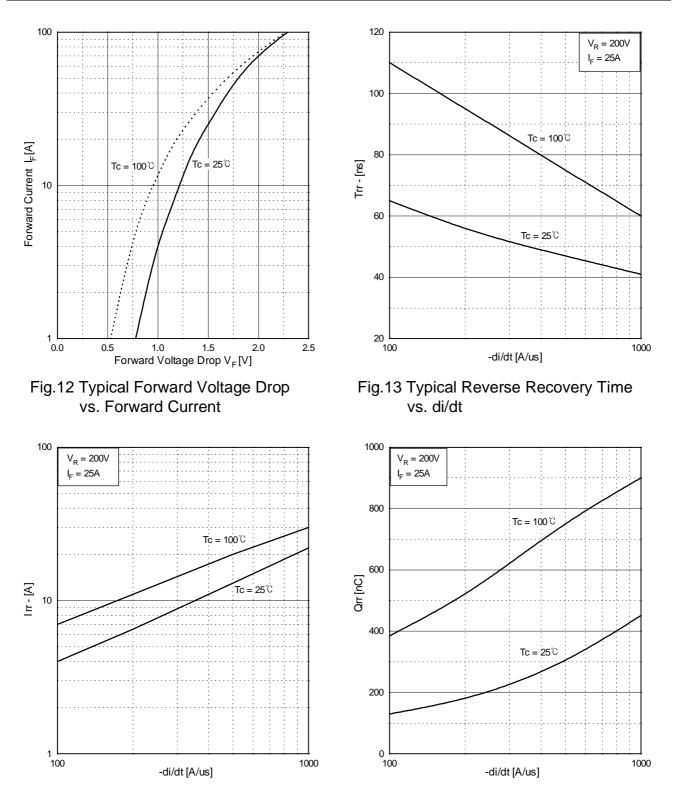


Fig.14 Typical Reverse Recovery Current vs. di/dt

Fig.15 Typical Stored Charge vs. di/dt



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